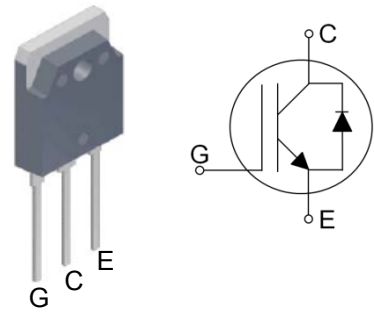


Features

- 600V Field Stop Trench IGBT Technology
- Low Conduction Loss
- Positive Temperature Coefficient
- Easy Parallel Operation
- RoHS Compliant
- JEDEC Qualification

Applications

UPS, Welder, Inverter, Solar



| Device | Package | Marking | Remark |
|--------------|---------|--------------|--------|
| TGAN40N60F2D | TO-3PN | TGAN40N60F2D | RoHS |

Absolute Maximum Ratings

| Parameter | Symbol | Value | Unit |
|---|-----------|-----------------------------------|------------------|
| Collector-Emitter Voltage | V_{CES} | 600 | V |
| Gate-Emitter Voltage | V_{GES} | ± 20 | V |
| Continuous Collector Current | I_C | $T_C = 25\text{ }^\circ\text{C}$ | 80 |
| | | $T_C = 100\text{ }^\circ\text{C}$ | 40 |
| Pulsed Collector Current (Note 1) | I_{CM} | 120 | A |
| Diode Continuous Forward Current | I_F | 20 | A |
| Diode Pulsed Forward Current (Note 2) | I_{FM} | 200 | A |
| Power Dissipation | P_D | $T_C = 25\text{ }^\circ\text{C}$ | 236 |
| | | $T_C = 100\text{ }^\circ\text{C}$ | 94 |
| Operating Junction Temperature | T_{vj} | -55 ~ 150 | $^\circ\text{C}$ |
| Storage Temperature Range | T_{STG} | -55 ~ 150 | $^\circ\text{C}$ |
| Maximum lead temperature for soldering purposes, 1/8" from case for 5 seconds | T_L | 300 | $^\circ\text{C}$ |

- Notes :
- (1) Repetitive rating : Pulse width limited by maximum junction temperature, During production, high current switching capability is 100% verified with the inductive load single-pulse switching test. ($I_C=120A$)
 - (2) Repetitive rating : Pulse width limited by maximum junction temperature.

Thermal Characteristics

| Parameter | Symbol | Value | Unit |
|---|-------------------------|-------|--------------------|
| Maximum Thermal resistance, Junction-to-Case | $R_{\theta JC}$ (IGBT) | 0.53 | $^\circ\text{C/W}$ |
| Maximum Thermal resistance, Junction-to-Case | $R_{\theta JC}$ (DIODE) | 1.43 | $^\circ\text{C/W}$ |
| Maximum Thermal resistance, Junction-to-Ambient | $R_{\theta JA}$ | 40 | $^\circ\text{C/W}$ |

Electrical Characteristics of the IGBT $T_{vj}=25^{\circ}\text{C}$, unless otherwise noted

| Parameter | Symbol | Test condition | Min. | Typ. | Max. | Unit |
|-----------|--------|----------------|------|------|------|------|
|-----------|--------|----------------|------|------|------|------|

OFF

| | | | | | | |
|---------------------------------------|--------------|-----------------------------------|-----|-----|-----------|----------|
| Collector – Emitter Breakdown Voltage | BV_{CES} | $V_{GE} = 0V, I_C = 1mA$ | 600 | -- | -- | V |
| Zero Gate Voltage Collector Current | I_{CES} | $V_{CE} = 600V, V_{GE} = 0V$ | -- | -- | 1 | mA |
| Gate – Emitter Leakage Current | I_{GES} | $V_{CE} = 0V, V_{GE} = \pm 20V$ | -- | -- | ± 250 | nA |
| Integrated Gate Resistance | $R_{G(int)}$ | $f = 1MHz, \text{Open Collector}$ | -- | 2.2 | -- | Ω |

ON

| | | | | | | |
|--|---------------|---|-----|------|------|---|
| Gate – Emitter Threshold Voltage | $V_{GE(TH)}$ | $V_{GE} = V_{CE}, I_C = 40mA$ | 4.5 | 6.0 | 7.5 | V |
| Collector – Emitter Saturation Voltage | $V_{CE(SAT)}$ | $V_{GE} = 15V, I_C = 40A, T_{vj} = 25^{\circ}\text{C}$ | -- | 1.70 | 2.20 | V |
| | | $V_{GE} = 15V, I_C = 40A, T_{vj} = 150^{\circ}\text{C}$ | -- | 2.10 | -- | V |

DYNAMIC

| | | | | | | |
|------------------------------|-----------|---|----|------|-----|----|
| Input Capacitance | C_{IES} | $V_{CE} = 30V$ $V_{GE} = 0V$ $f = 1MHz$ | -- | 2620 | -- | pF |
| Output Capacitance | C_{OES} | | -- | 129 | -- | pF |
| Reverse Transfer Capacitance | C_{RES} | | -- | 74 | -- | pF |
| Total Gate Charge | Q_g | $V_{CC} = 400V, I_C = 40A$ $V_{GE} = 15V$ | -- | 110 | 165 | nC |
| Gate-Emitter Charge | Q_{ge} | | -- | 17 | 26 | nC |
| Gate-Collector Charge | Q_{gc} | | -- | 57 | 86 | nC |

SWITCHING (Note 3)

| | | | | | | |
|-------------------------|--------------|--|----|------|------|----|
| Turn-On Delay Time | $t_{d(on)}$ | $V_{CC} = 400V, I_C = 20A$ $R_G = 5\Omega, V_{GE} = 15V$ Inductive Load, $T_{vj} = 25^{\circ}\text{C}$ | -- | 28 | -- | ns |
| Rise Time | t_r | | -- | 35 | -- | ns |
| Turn-Off Delay Time | $t_{d(off)}$ | | -- | 80 | -- | ns |
| Fall Time | t_f | | -- | 14 | -- | ns |
| Turn-On Switching Loss | E_{ON} | | -- | 0.47 | -- | mJ |
| Turn-Off Switching Loss | E_{OFF} | | -- | 0.07 | -- | mJ |
| Total Switching Loss | E_{TS} | | -- | 0.54 | -- | mJ |
| Turn-On Delay Time | $t_{d(on)}$ | $V_{CC} = 400V, I_C = 40A$ $R_G = 5\Omega, V_{GE} = 15V$ Inductive Load, $T_{vj} = 25^{\circ}\text{C}$ | -- | 25 | -- | ns |
| Rise Time | t_r | | -- | 67 | -- | ns |
| Turn-Off Delay Time | $t_{d(off)}$ | | -- | 78 | -- | ns |
| Fall Time | t_f | | -- | 21 | -- | ns |
| Turn-On Switching Loss | E_{ON} | | -- | 1.30 | 1.95 | mJ |
| Turn-Off Switching Loss | E_{OFF} | | -- | 0.16 | 0.24 | mJ |
| Total Switching Loss | E_{TS} | | -- | 1.46 | 2.19 | mJ |

Electrical Characteristics of the IGBT $T_{vj}=25^{\circ}\text{C}$, unless otherwise noted

| Parameter | Symbol | Test condition | Min. | Typ. | Max. | Unit |
|---------------------------|--------------|--|------|------|------|------|
| SWITCHING (Note 3) | | | | | | |
| Turn-On Delay Time | $t_{d(on)}$ | $V_{CC} = 400\text{V}, I_C = 20\text{A}$ $R_G = 5\Omega, V_{GE} = 15\text{V}$ Inductive Load, $T_{vj} = 150^{\circ}\text{C}$ | -- | 22 | -- | ns |
| Rise Time | t_r | | -- | 27 | -- | ns |
| Turn-Off Delay Time | $t_{d(off)}$ | | -- | 88 | -- | ns |
| Fall Time | t_f | | -- | 20 | -- | ns |
| Turn-On Switching Loss | E_{ON} | | -- | 0.88 | -- | mJ |
| Turn-Off Switching Loss | E_{OFF} | | -- | 0.20 | -- | mJ |
| Total Switching Loss | E_{TS} | -- | 1.08 | -- | mJ | |
| Turn-On Delay Time | $t_{d(on)}$ | $V_{CC} = 400\text{V}, I_C = 40\text{A}$ $R_G = 5\Omega, V_{GE} = 15\text{V}$ Inductive Load, $T_{vj} = 150^{\circ}\text{C}$ | -- | 24 | -- | ns |
| Rise Time | t_r | | -- | 65 | -- | ns |
| Turn-Off Delay Time | $t_{d(off)}$ | | -- | 80 | -- | ns |
| Fall Time | t_f | | -- | 25 | -- | ns |
| Turn-On Switching Loss | E_{ON} | | -- | 1.88 | 2.82 | mJ |
| Turn-Off Switching Loss | E_{OFF} | | -- | 0.34 | 0.51 | mJ |
| Total Switching Loss | E_{TS} | -- | 2.22 | 3.33 | mJ | |

Notes :

(3) Not subject to production test – verified by design/characterization

Electrical Characteristics of the DIODE $T_{vj}=25^{\circ}\text{C}$, unless otherwise noted

| Parameter | Symbol | Test condition | Min. | Typ. | Max. | Unit |
|--------------------------|----------|---|------|------|------|------|
| Diode Forward Voltage | V_{FM} | $I_F = 20\text{A}, T_{vj} = 25^{\circ}\text{C}$ | -- | 1.70 | -- | V |
| | | $I_F = 20\text{A}, T_{vj} = 150^{\circ}\text{C}$ | -- | 1.46 | -- | V |
| | | $I_F = 40\text{A}, T_{vj} = 25^{\circ}\text{C}$ | -- | 2.10 | -- | V |
| | | $I_F = 40\text{A}, T_{vj} = 150^{\circ}\text{C}$ | -- | 1.95 | -- | V |
| Reverse Recovery Time | t_{rr} | $I_F = 20\text{A},$ $di/dt = 200\text{A}/\mu\text{s},$ $T_{vj} = 25^{\circ}\text{C}$ | -- | 58 | -- | ns |
| Reverse Recovery Current | I_{rr} | | -- | 5.0 | -- | A |
| Reverse Recovery Charge | Q_{rr} | | -- | 168 | -- | nC |
| Reverse Recovery Time | t_{rr} | $I_F = 20\text{A},$ $di/dt = 200\text{A}/\mu\text{s},$ $T_{vj} = 150^{\circ}\text{C}$ | -- | 155 | -- | ns |
| Reverse Recovery Current | I_{rr} | | -- | 10.2 | -- | A |
| Reverse Recovery Charge | Q_{rr} | | -- | 950 | -- | nC |
| Reverse Recovery Time | t_{rr} | $I_F = 40\text{A},$ $di/dt = 200\text{A}/\mu\text{s},$ $T_{vj} = 25^{\circ}\text{C}$ | -- | 60 | -- | ns |
| Reverse Recovery Current | I_{rr} | | -- | 5.7 | -- | A |
| Reverse Recovery Charge | Q_{rr} | | -- | 196 | -- | nC |
| Reverse Recovery Time | t_{rr} | $I_F = 40\text{A},$ $di/dt = 200\text{A}/\mu\text{s},$ $T_{vj} = 150^{\circ}\text{C}$ | -- | 158 | -- | ns |
| Reverse Recovery Current | I_{rr} | | -- | 10.8 | -- | A |
| Reverse Recovery Charge | Q_{rr} | | -- | 1120 | -- | nC |

IGBT Characteristics

Fig. 1 IGBT Output Characteristics

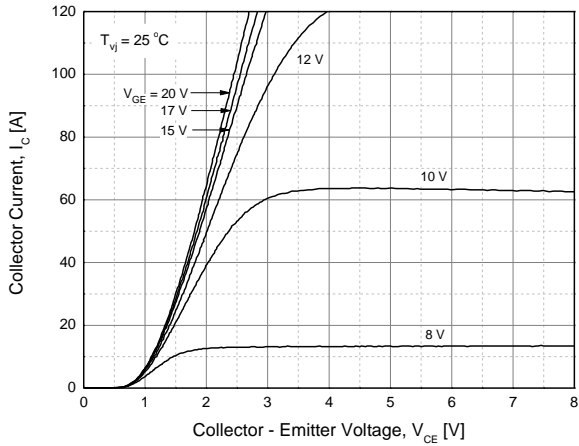


Fig. 2 IGBT Output Characteristics

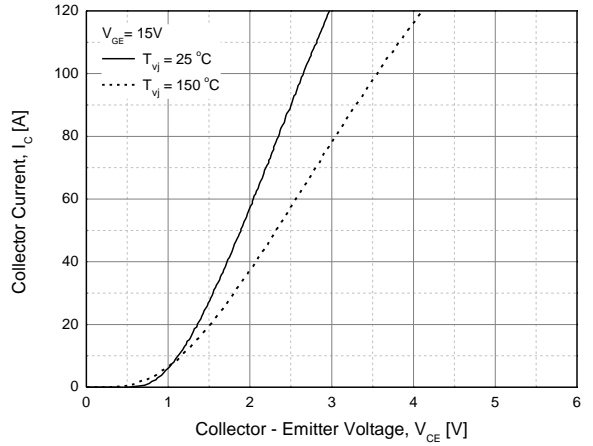


Fig. 3 IGBT Saturation Voltage vs. Junction Temperature

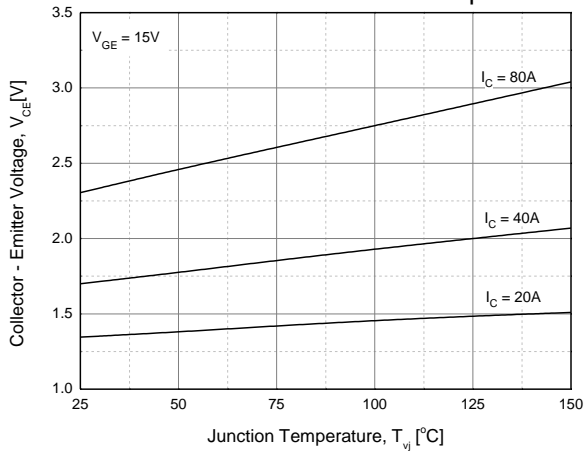


Fig. 4 IGBT Saturation Voltage vs. Gate Bias

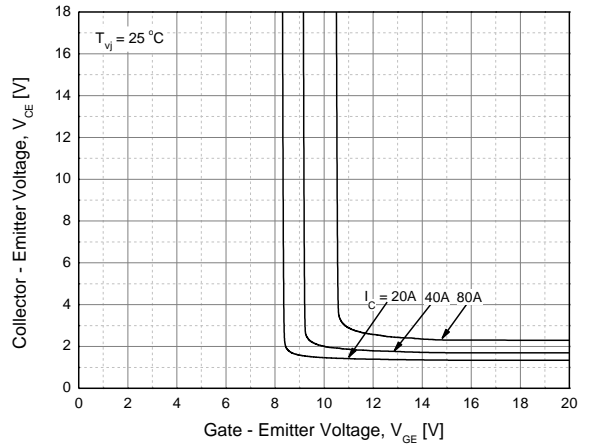


Fig. 5 IGBT Saturation Voltage vs. Gate Bias

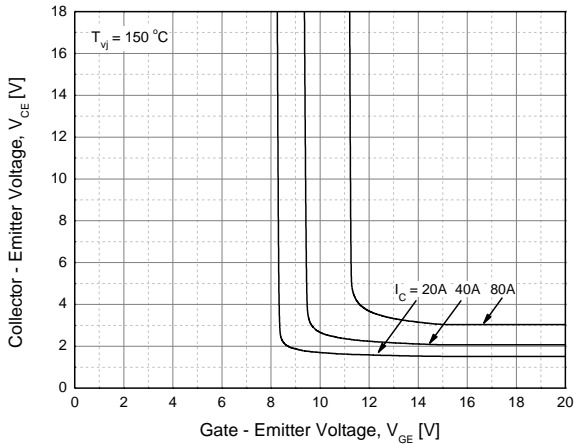
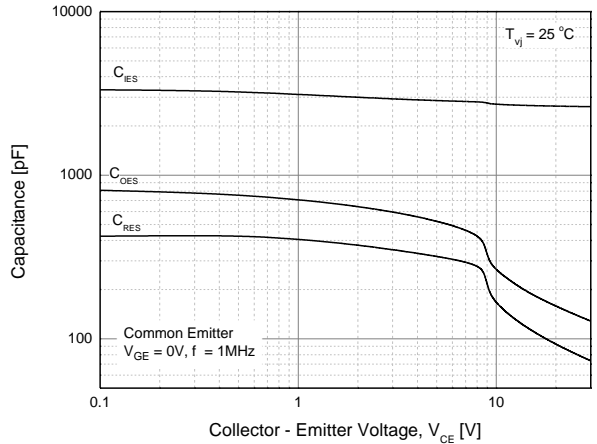


Fig. 6 IGBT Capacitance Characteristics



IGBT Characteristics

Fig. 7 Turn-on Time vs. Gate Resistor

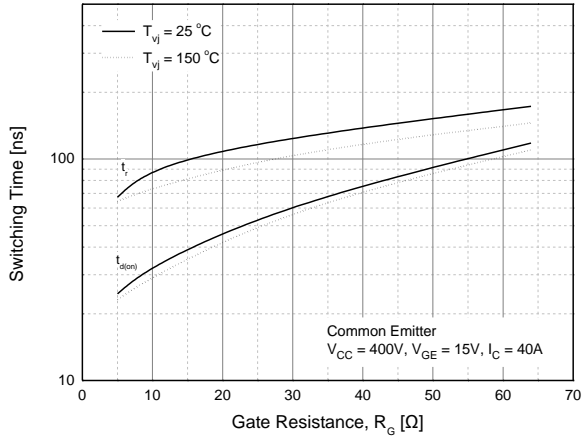


Fig. 8 Turn-off Time vs. Gate Resistor

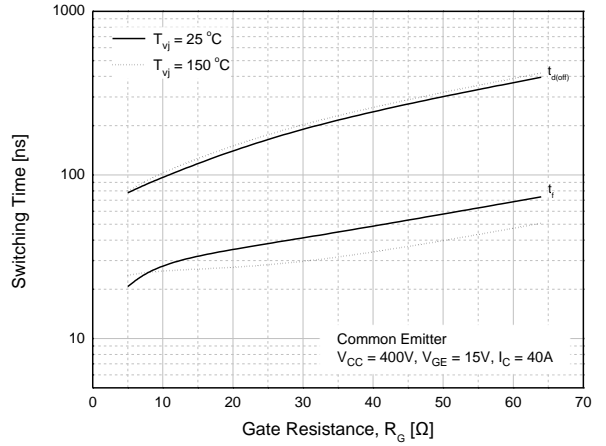


Fig. 9 Switching Loss vs. Gate Resistor

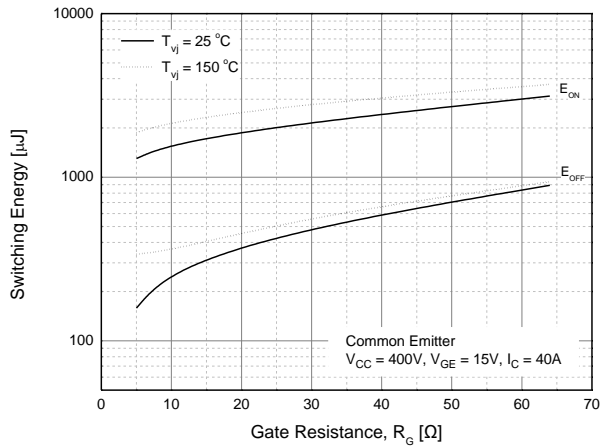


Fig. 10 Turn-on Time vs. Collector Current

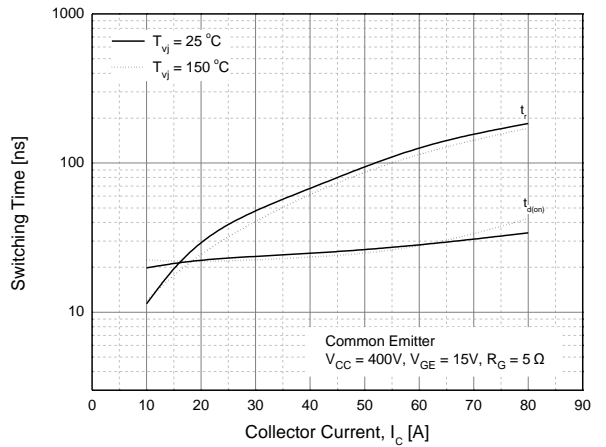


Fig. 11 Turn-off Time vs. Collector Current

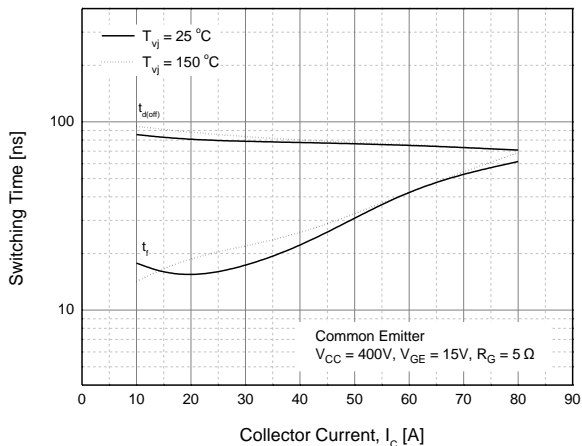
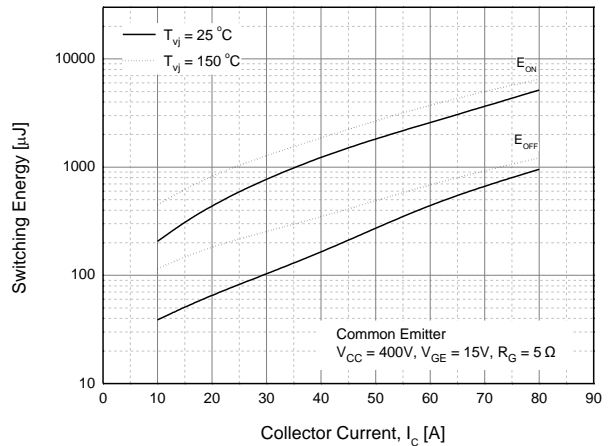


Fig. 12 Switching Loss vs. Collector Current



IGBT Characteristics

Fig. 13 Gate Charge Characteristics

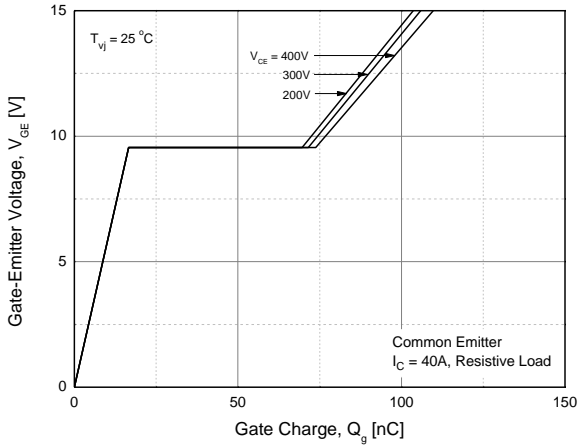


Fig. 14 SOA

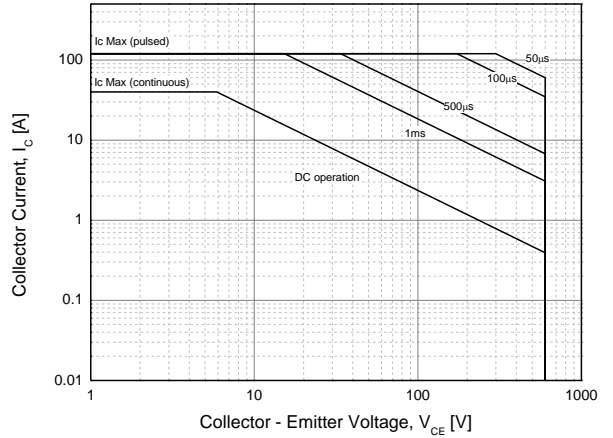


Fig. 15 RBSOA

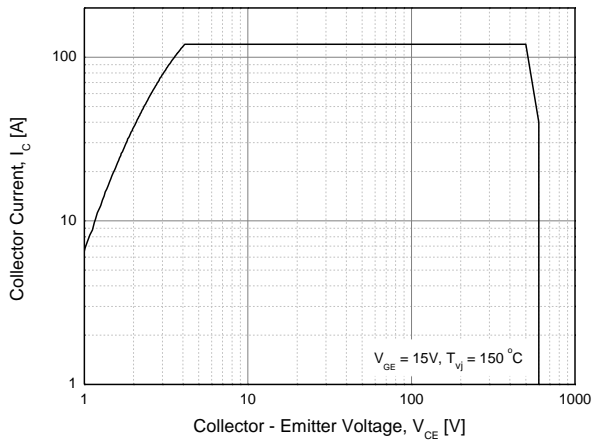


Fig. 16 Transient Thermal Impedance of IGBT

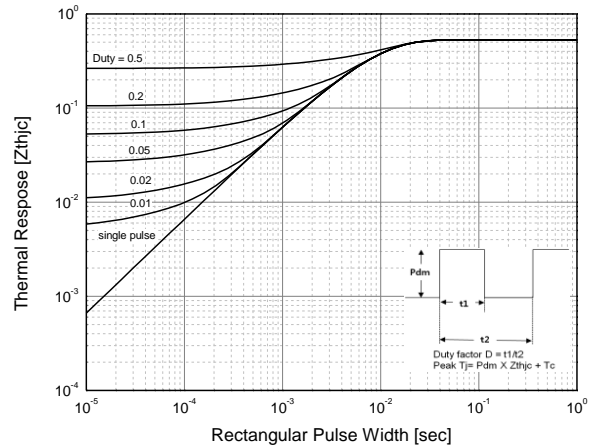
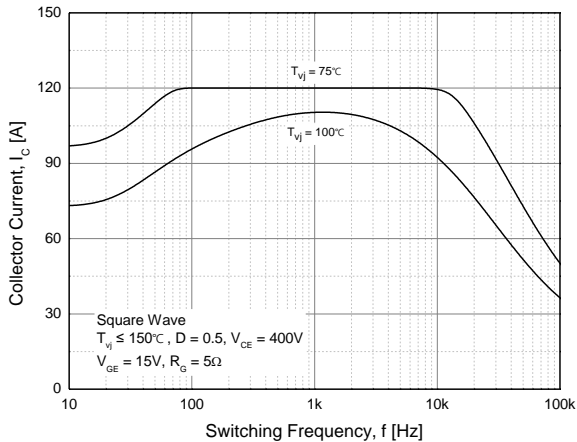


Fig. 17 Load Current vs. Frequency



Diode Characteristics

Fig. 18 Diode Conduction Characteristics

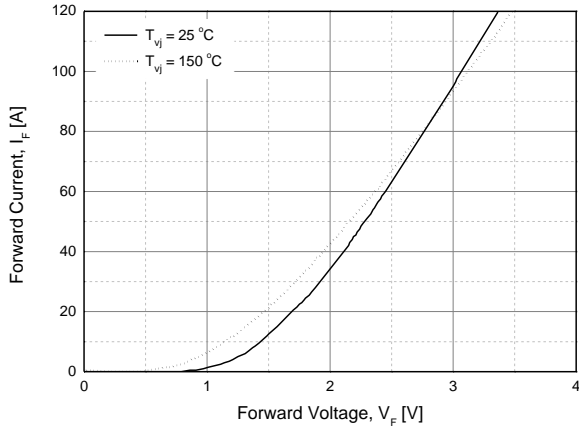


Fig. 19 Reverse Recovery Current vs. Forward Current

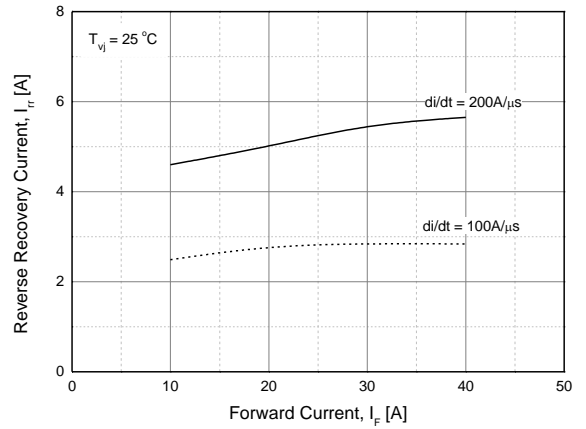


Fig. 20 Reverse Recovery Charge vs. Forward Current

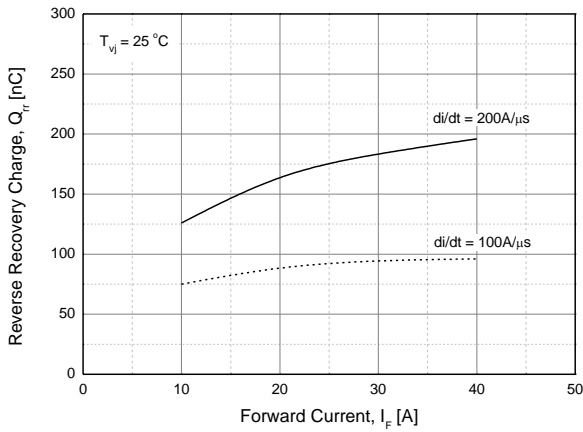
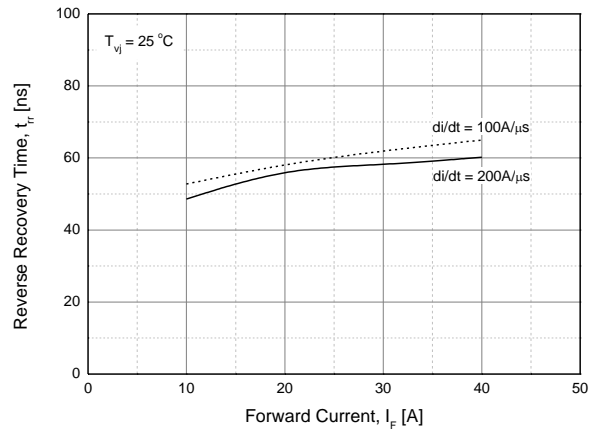
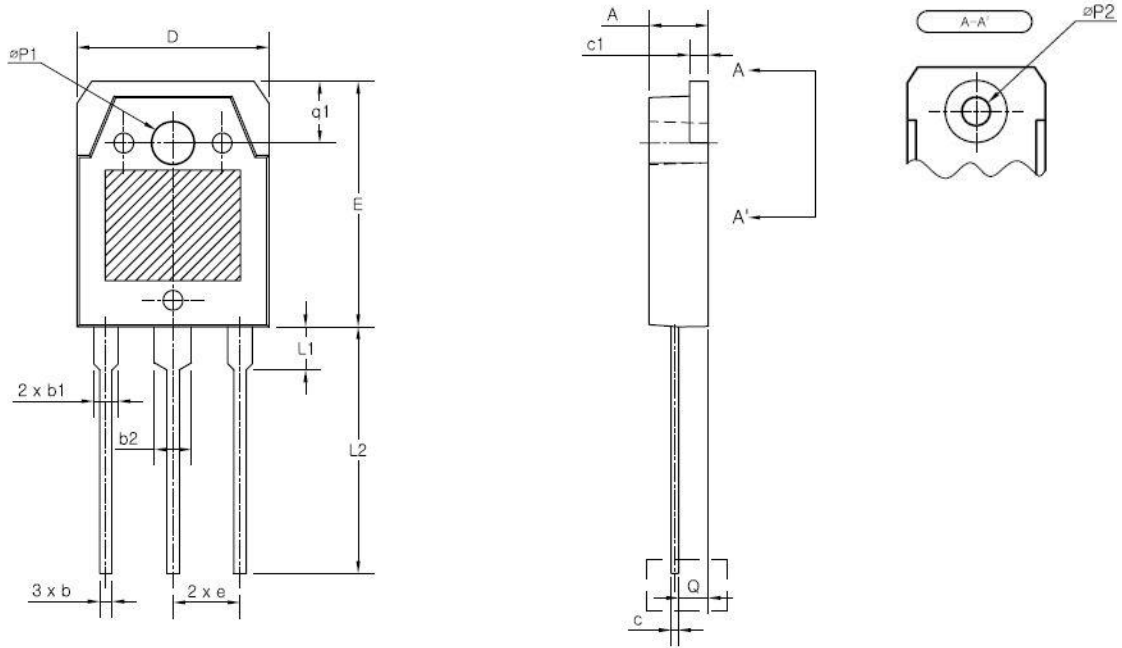


Fig. 21 Reverse Recovery Time vs. Forward Current



TO-3PN MECHANICAL DATA



| SYMBOL | MIN | NOM | MAX |
|--------|--------|-------|-------|
| A | 4.60 | 4.80 | 5.00 |
| b | 0.80 | 1.00 | 1.20 |
| b1 | 1.80 | 2.00 | 2.20 |
| b2 | 2.80 | 3.00 | 3.20 |
| c | 0.55 | 0.60 | 0.75 |
| c1 | 1.45 | 1.50 | 1.65 |
| D | 15.40 | 15.60 | 15.80 |
| E | 19.70 | 19.90 | 20.10 |
| e | 5.15 | 5.45 | 5.75 |
| L1 | 3.30 | 3.50 | 3.70 |
| L2 | 19.80 | 20.00 | 20.20 |
| aP1 | 3.30 | 3.40 | 3.50 |
| aP2 | (3.20) | | |
| Q | 2.20 | 2.40 | 2.60 |
| q1 | 4.80 | 5.00 | 5.20 |

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